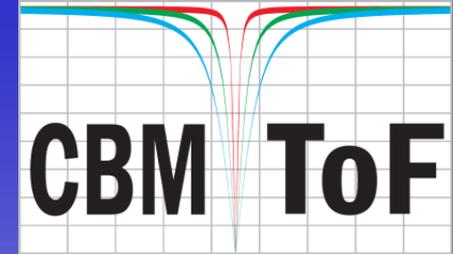


RPC 2016 – XIII Workshop on Resistive Plate Chambers and Related Detectors



Performance studies of a single HV stack MRPC prototype for CBM

Ingo Deppner

Physikalisches Institut der Uni. Heidelberg

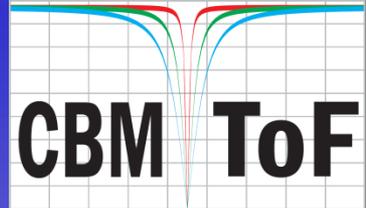
Outline:

- **CBM-ToF requirements**
- **TDR ToF wall design**
- **Test beam time at GSI**
- **Single stack vs. double stack**
- **Performance results**
- **Summary / Outlook**

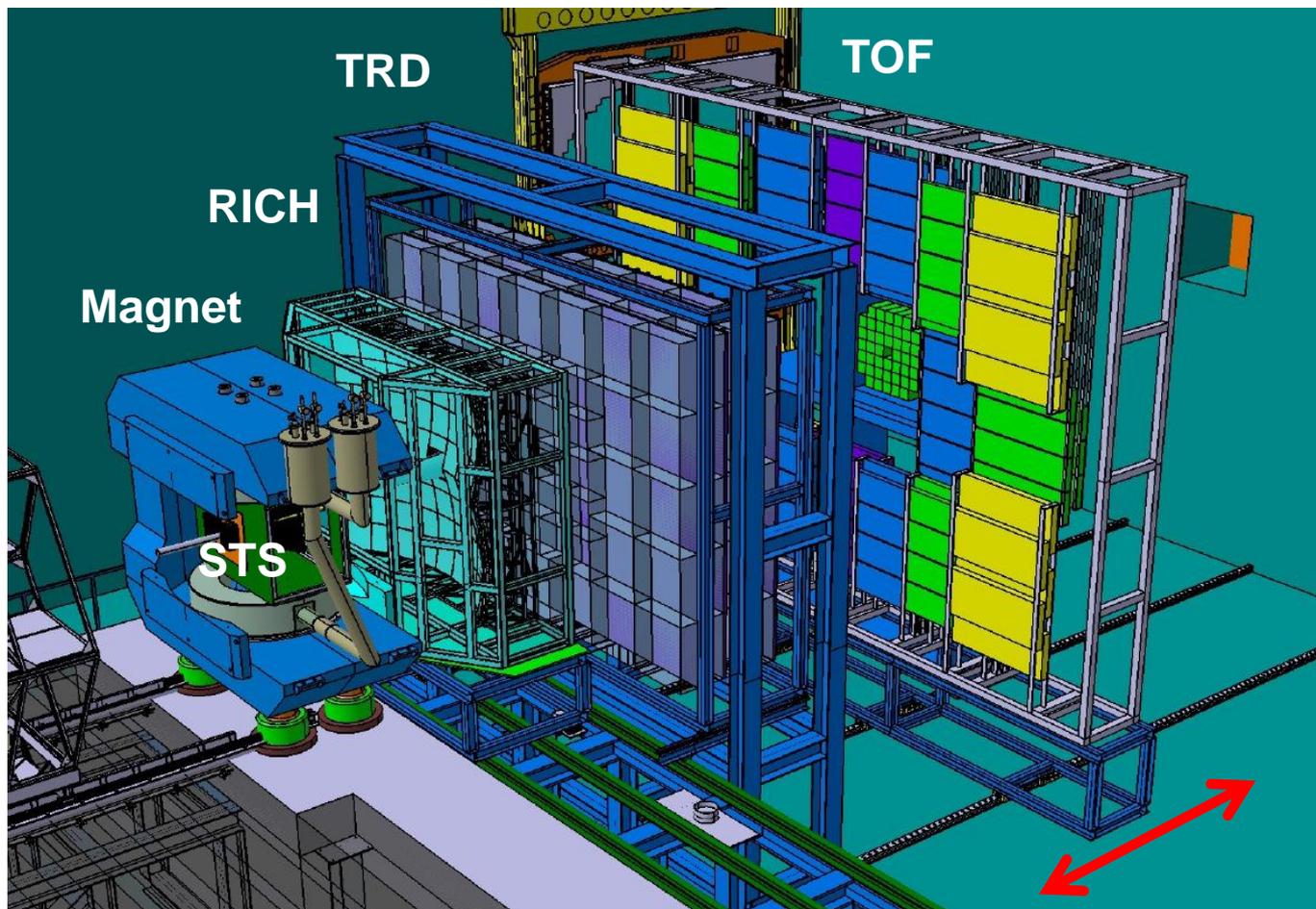




CBM spectrometer



Engineering design of the CBM experiment

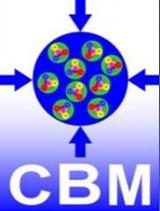


Nominal ToF position is between 6 m and 10 m from the target

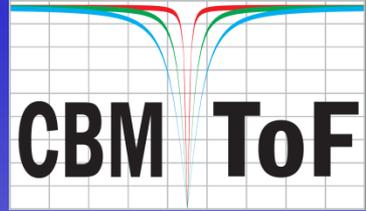
Movable design allows for optimization of the detection efficiency of weakly decaying particles (Kaons)

Interaction rate 10 MHz

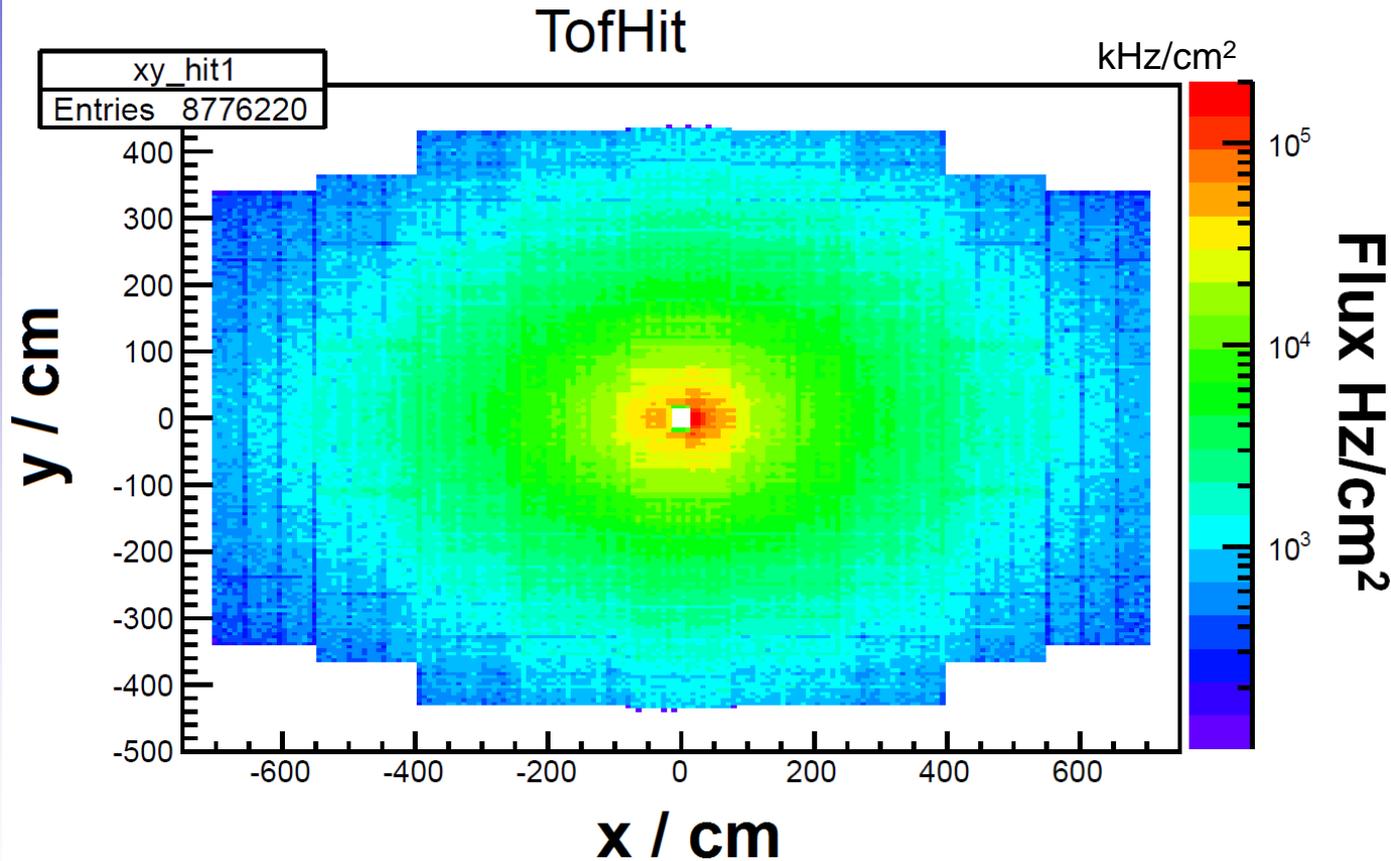




Incident particle flux



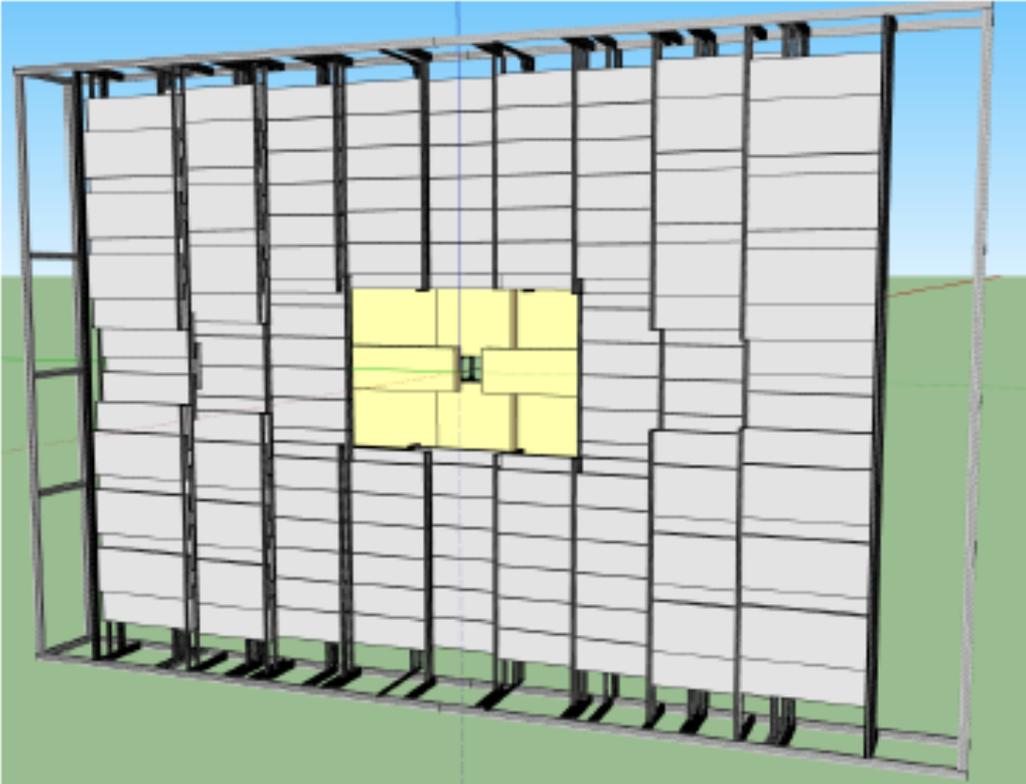
URQMD simulated charged particle flux for Au + Au (minimum bias) events at 25 AGeV assuming an interaction rate of 10 MHz



- Flux ranging from 0.1 to 100 kHz/cm²
- At different regions MRPC counters with different rate capabilities are needed



Charged hadron identification is provided by Time-of-Flight (ToF) measurement

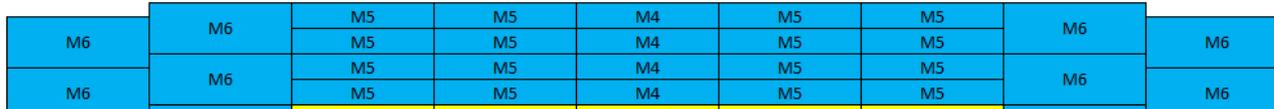
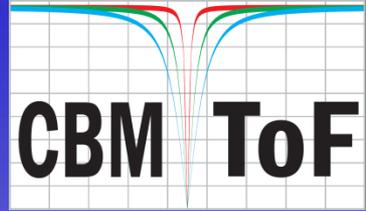


CBM-ToF Requirements

- Full system time resolution $\sigma_T \sim 80$ ps
- Efficiency > 95 %
- Rate capability ≤ 30 kHz/cm²
- Polar angular range $2.5^\circ - 25^\circ$
- Occupancy < 5 %
- Low power electronics
(~120.000 channels)
- **Free streaming data acquisition**



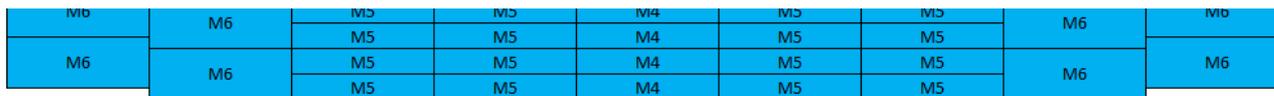
TDR ToF wall layout



- 6 types of modules (M1 – M6) only

Module notation	Number of modules	Module size mm ³	Number of MRPCs per module	Number of MRPCs in total	Number of cells per module	Number of cells in total
M1	2	1270 × 1417 × 239	32	64	2048	4096
M2	2	2140 × 705 × 239	27	54	1728	3456
M3	4	1850 × 1417 × 239	42	168	2688	10752
M4	24	1802 × 490 × 110	5	120	160	3840
M5	132	1802 × 490 × 110	5	660	160	21120
M6	62	1802 × 740 × 110	5	310	160	9920
Sum	226			1376		53184

Table 3.1: Numbers and dimensions of the modules.

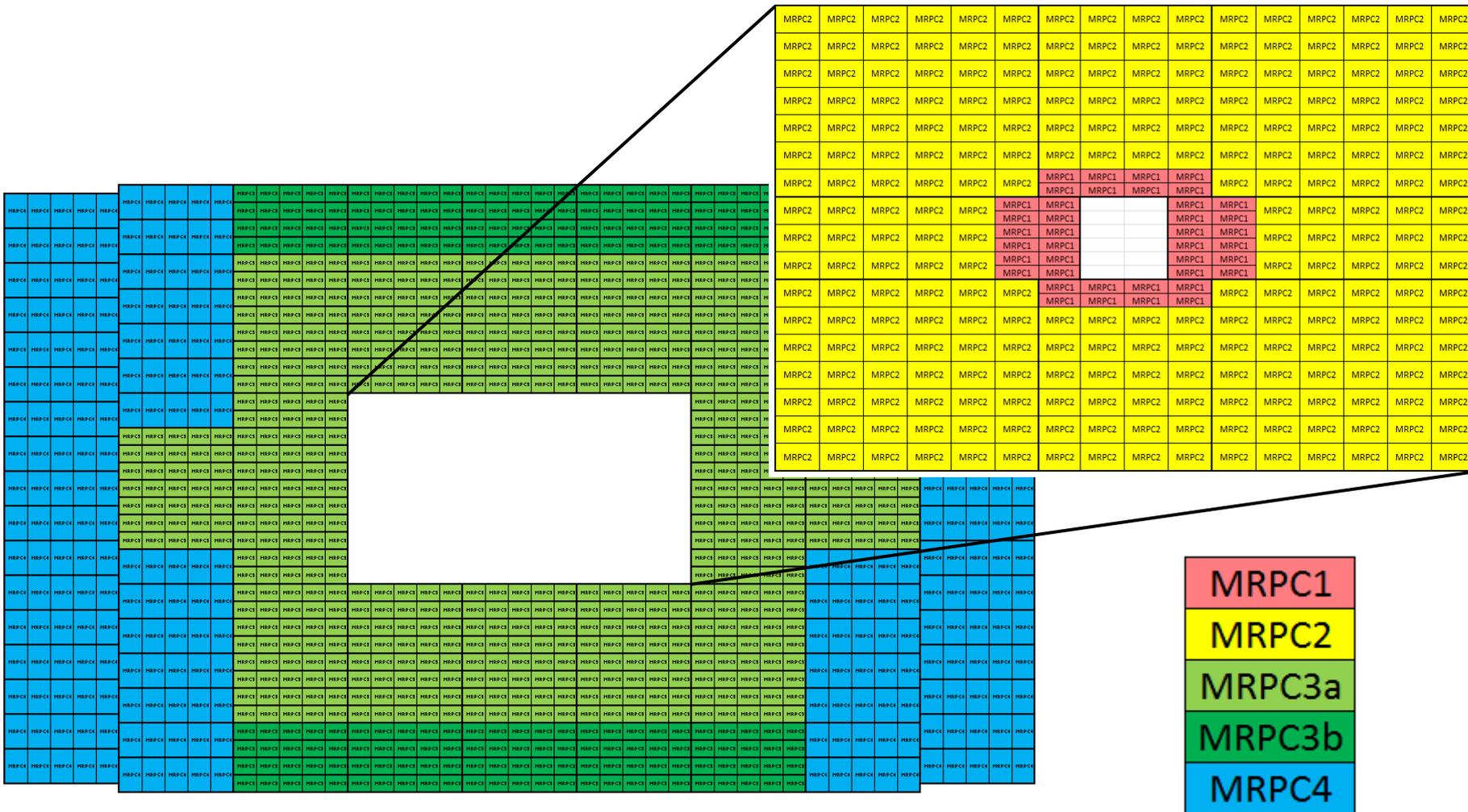
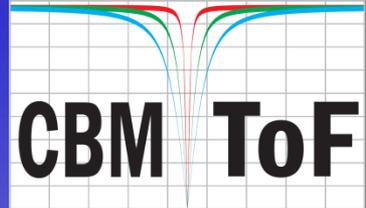


⇒ 106368 read-out channels





TDR MRPC arrangement



MRPC1
MRPC2
MRPC3a
MRPC3b
MRPC4



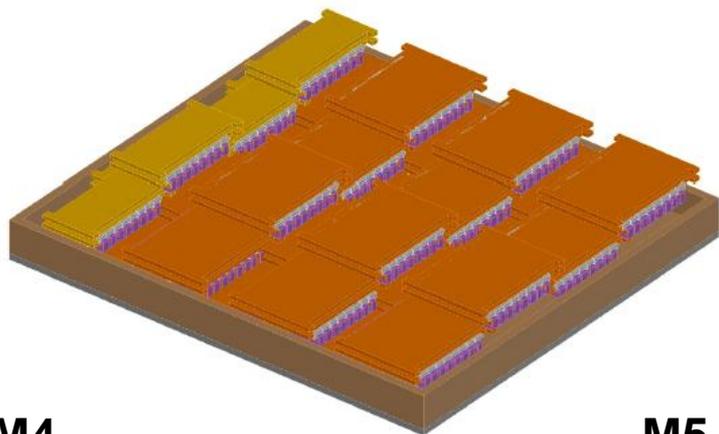
MRPC2															
MRPC2															
MRPC2															

MRPC notation	MRPC1	MRPC2	MRPC3a	MRPC3b	MRPC4
Number of MRPCs	40	246	580	200	310
Active area [mm ²]	300 × 100	300 × 200	320 × 270	320 × 270	320 × 530
Number of Strips per MRPC	64	64	32	32	32
Strip length [mm]	100	200	270	270	530
Granularity (cell size) [mm ²]	472.4	944.8	2700	2700	5300
Number of gas gaps	10	10	8	8	8
Gap size μm	140	140	220	220 140	220 140
Glass size [mm ²]	320 × 100	320 × 200	330 × 280	330 × 280	330 × 540
Glass thickness [mm]	0.7	0.7	1.0 0.7	0.5 0.28	0.5 0.28
Number of glass plates	12	12	9	8 12	8 12
Glass type	low res.	low res.	low res.	float	float
Total glass surface [m ²]	15.36	188.93	482.33	166.32	497.18

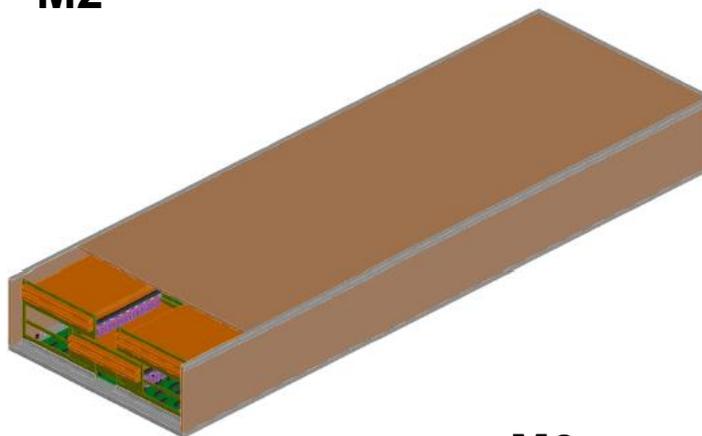
Table 3.2: Numbers and dimensions of different MRPC counters.



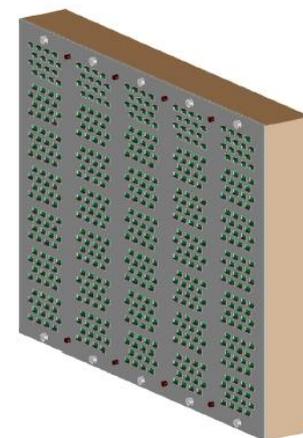
M1



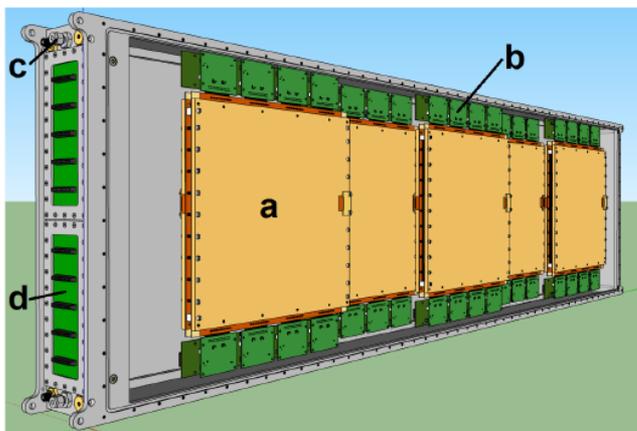
M2



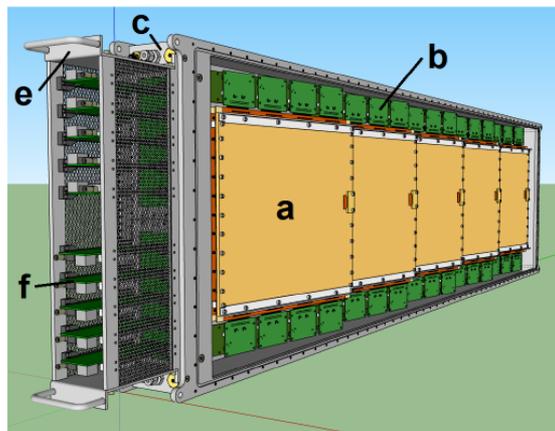
M3



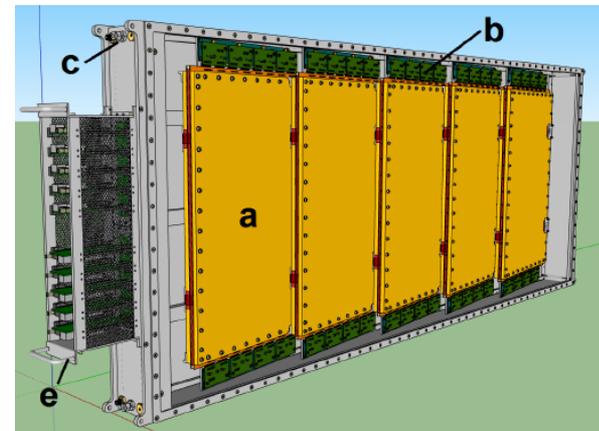
M4



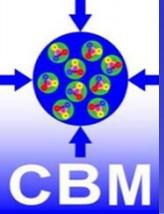
M5



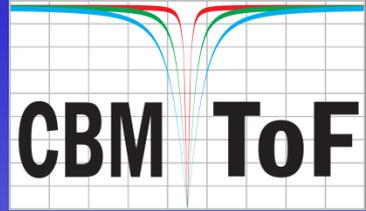
M6



a: MRPC, b: Preamplifier (PADI), c: feed-through PCB, d: connectors, e: crate, f: TDC and read out

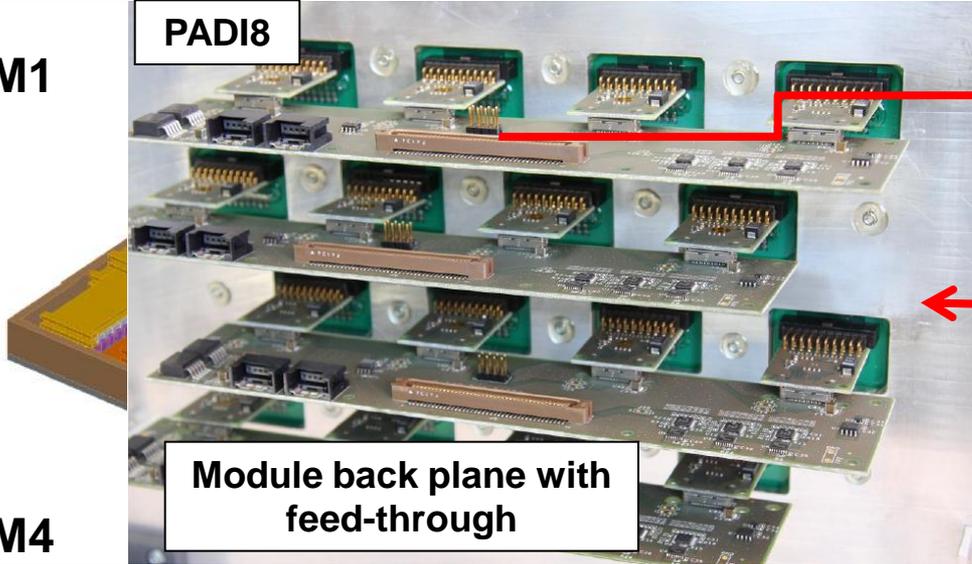


Modules

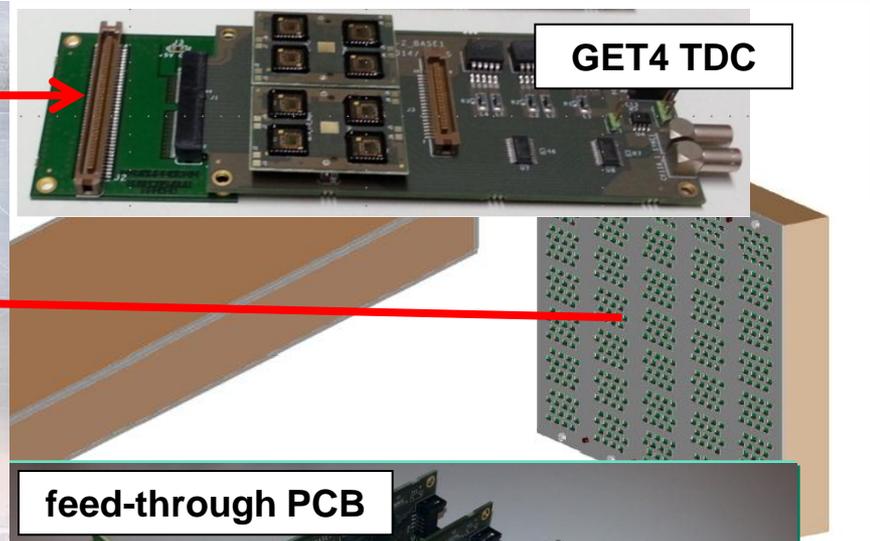


M1

PADI8



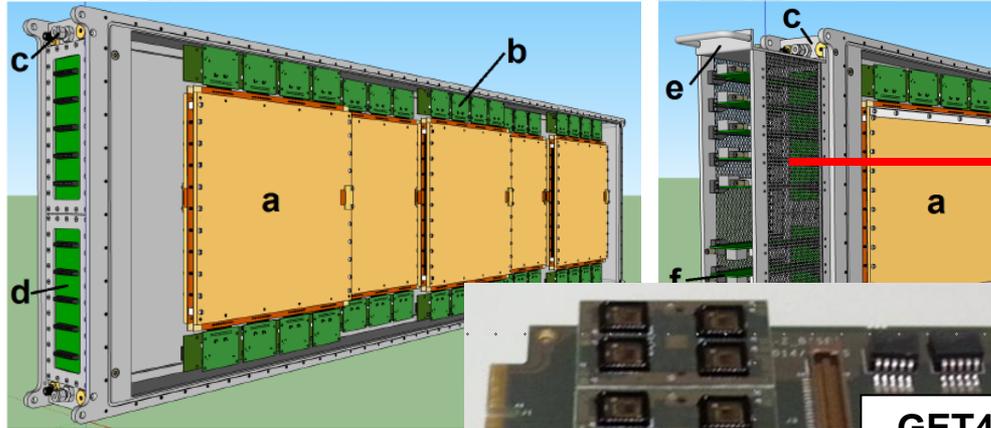
Module back plane with feed-through



GET4 TDC

feed-through PCB

M4



a: MRPC, b: Preamplifier



GET4 TDC

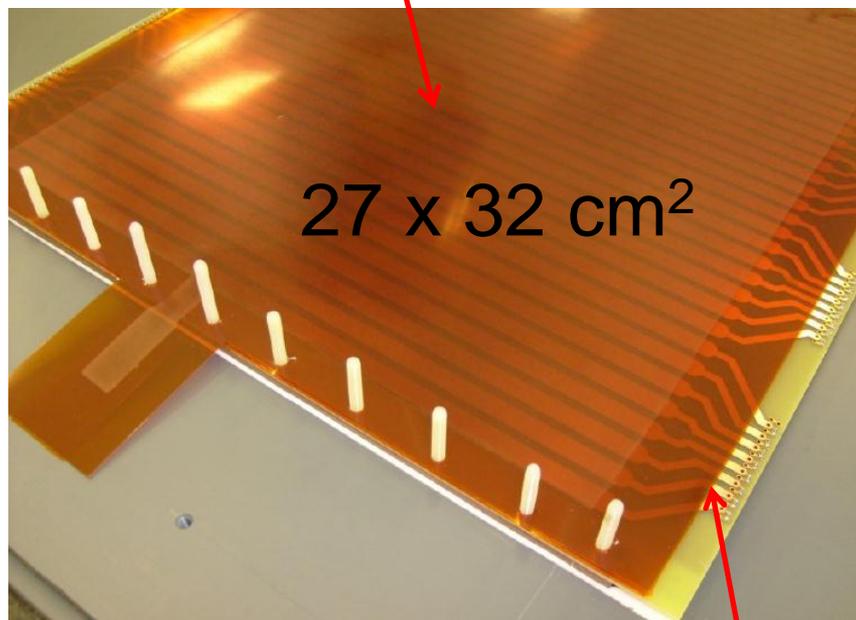
32 channels

Gent 22 - 26.02.2016

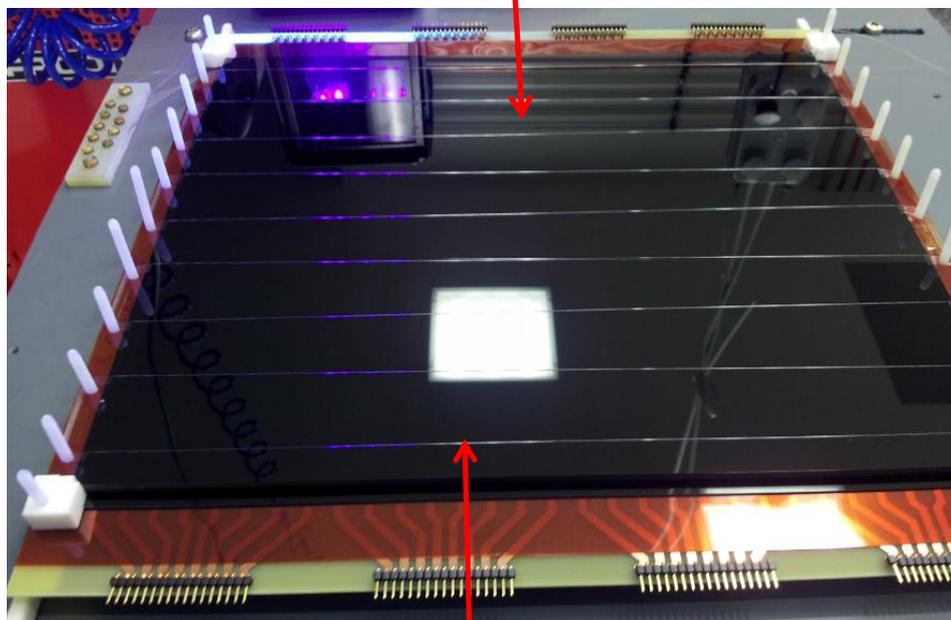


Full size demonstrator for high rates (1 - 10kHz/cm²)

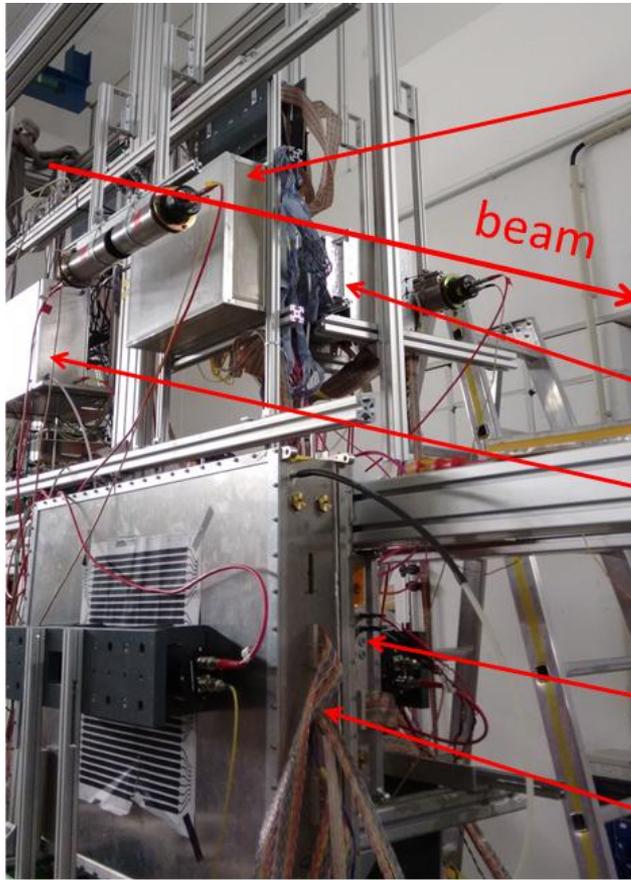
HV electrode
(Licron®)



Low resistive
glass



Setup



Buc2013

beam

Buc-Ref

PAD-MRPC

HD-Ref

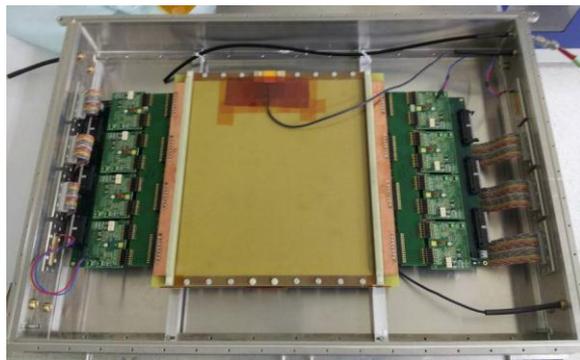
HDMRPC-P2
THU-Strip

- Test beam time in October 2014 at GSI (Hades cave)
- Sm beam with 1.2A GeV kin. energy
- 5 mm thick lead target
- „Uniform“ illumination of the counter surface
- Flux on the lower part of the setup was about few hundred Hz/cm²
- Delivered flux does not meet the CBM requirements
- R143a 85%, SF6 10%, iBut 5%

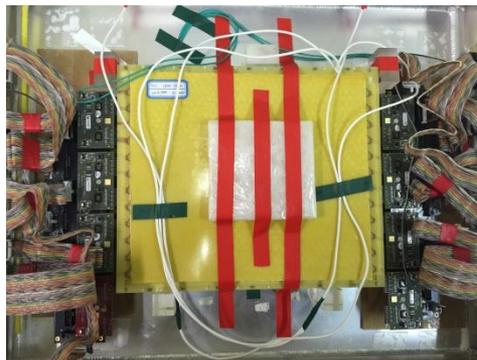
Full size demonstrator and reference MRPC used for the performance analysis

MRPC	<u>MRPC-P2 (HD)</u>	<u>THU-strip (Beijing)</u>	<u>MRPC-P5 (HD)</u>
glass stack	differential	differential	differential
active area	single	double	single
strips	32 x 27 cm ²	24 x 27 cm ²	15 x 4 cm ²
strip / gap	32	24	16
glass type	7/3	7/3	7.6 / 1.8 mm
glass thickness	low resistive glass	low resistive glass	low resistive glass
number of gaps	0.7 mm	0.7 mm	1.0 mm
gap width	8	2 x 4	6
	220 μm	250 μm	220 μm

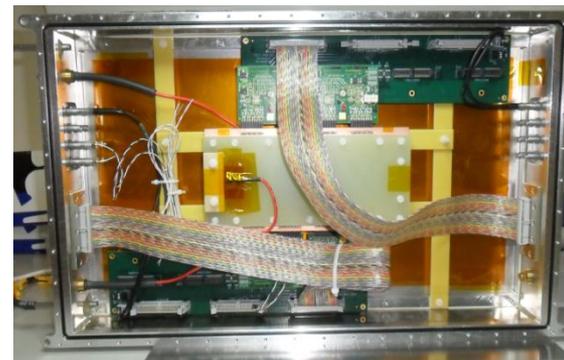
MRPC-P2



THU-strip



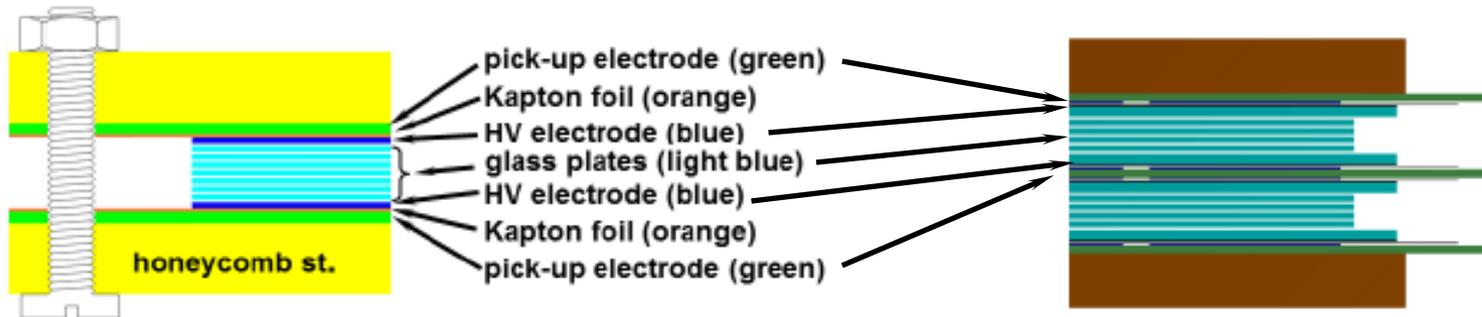
MRPC-P5



Differential singel stack
MRPC with 8 gaps

VS.

Differential double stack
MRPC with 2 x 4 gaps



Advantages

- simpler construction
- symmetric signal path
- fewer glass plates (#9)
- lower weight
- impedance matching easy possible (100Ω)

Disadvantages

- higher High Voltage (> ±10 kV)
- bigger cluster size

Advantages

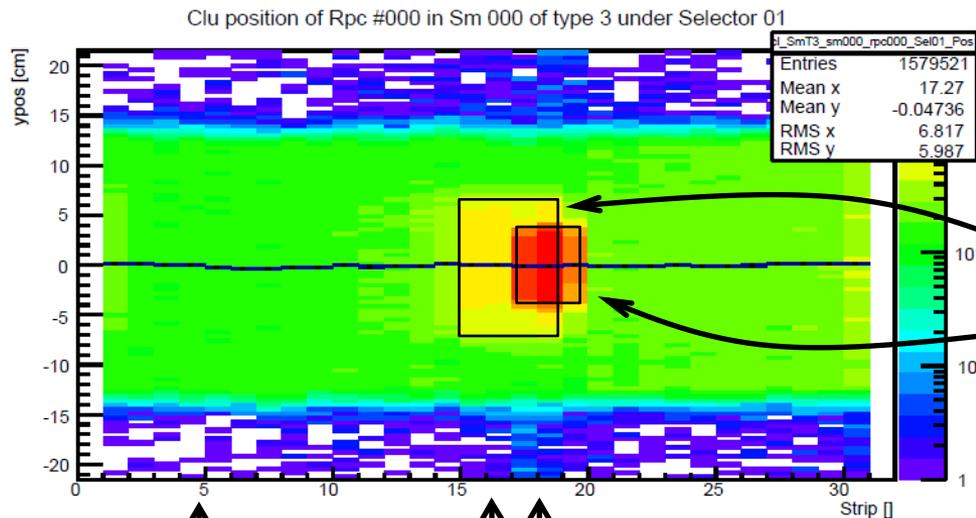
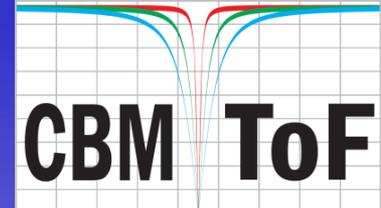
- lower High Voltage (< ±6 kV)
- smaller cluster size

Disadvantages

- more complex construction
- more glass plates (#10)
- impedance matching hardly possible (100Ω)



Counter occupation



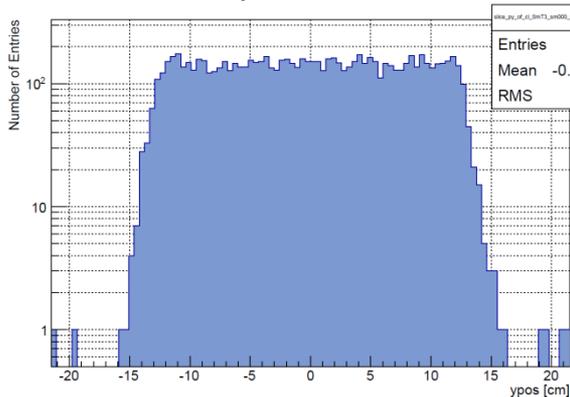
Active area of overlain counters

D.u.t. MRPC-P2: 32 x 27 cm²

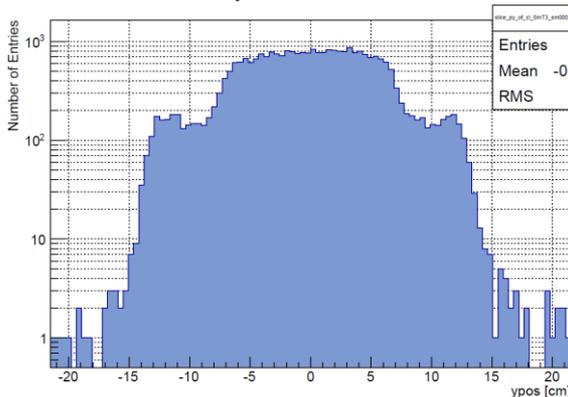
Reference MRPC-P5: 15 x 4 cm²

Plastic: 8 x 2 cm²

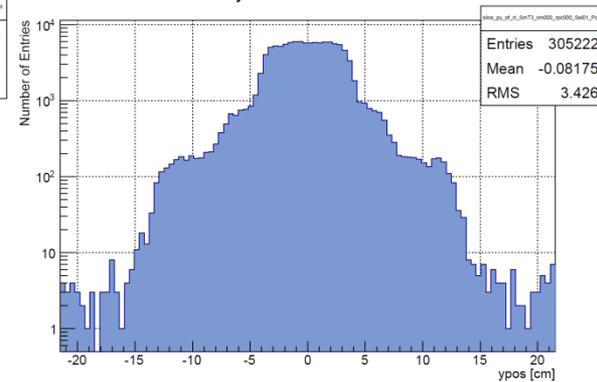
ProjectionY of binx=5

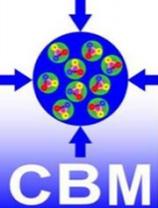


ProjectionY of binx=16

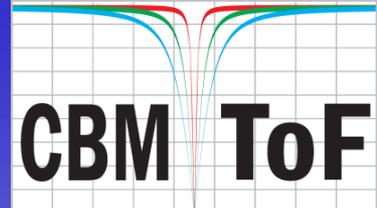


ProjectionY of binx=19

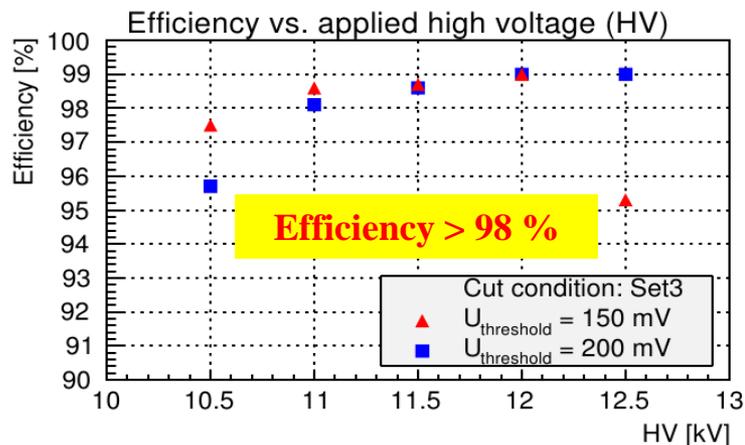




Efficiency

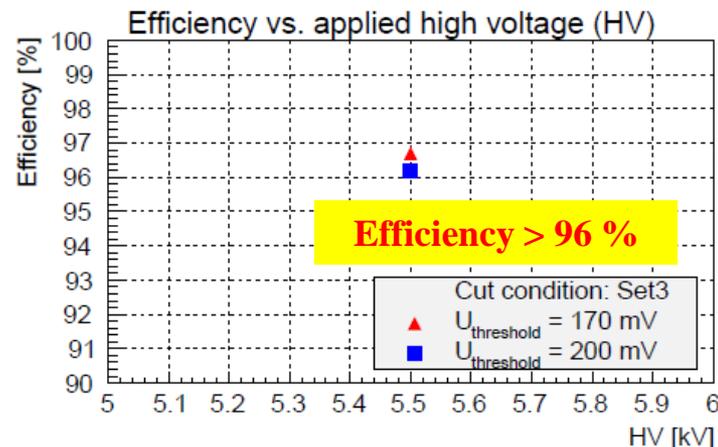


Differential singel stack MRPC
with 8 gaps



VS.

Differential double stack MRPC
with 2 x 4 gaps

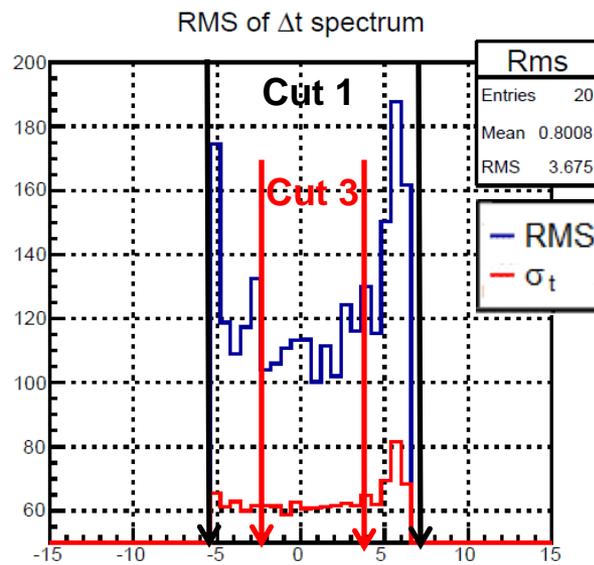
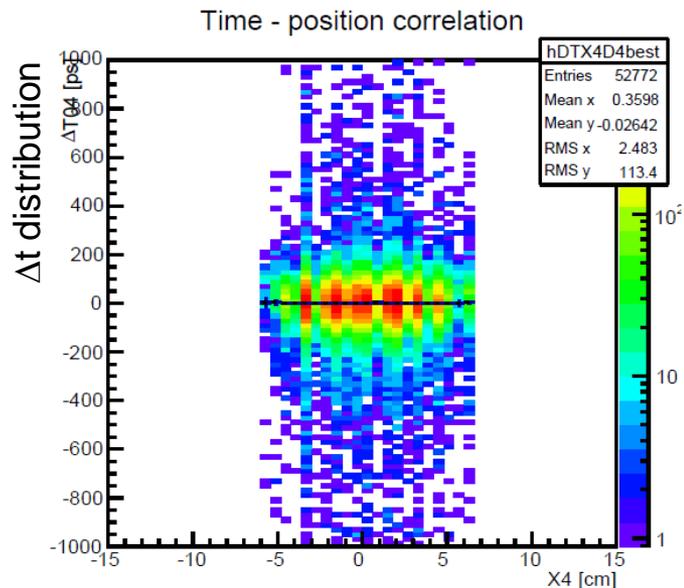
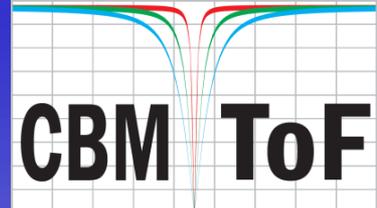


- Efficiency = $\frac{\text{Matched hit pairs in dut - ref}}{\text{Matched hit pairs in dia - ref}}$
- Data points at ± 11 kV in the left plot can be compared with ± 5.5 kV in the right plot.
- Single stack MRPC shows slightly better efficiency

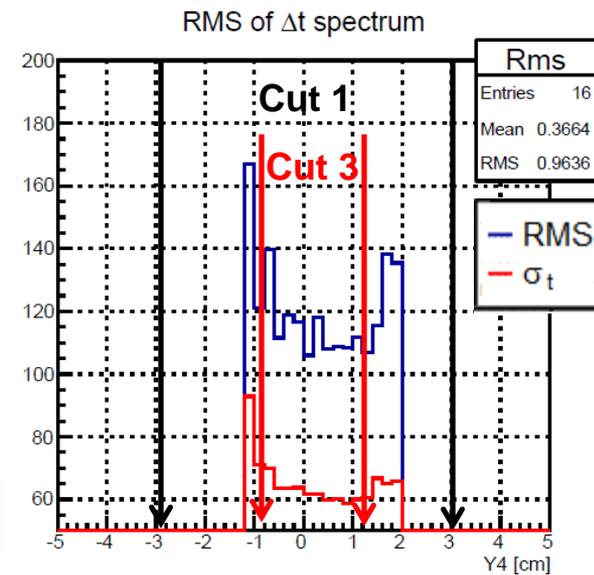
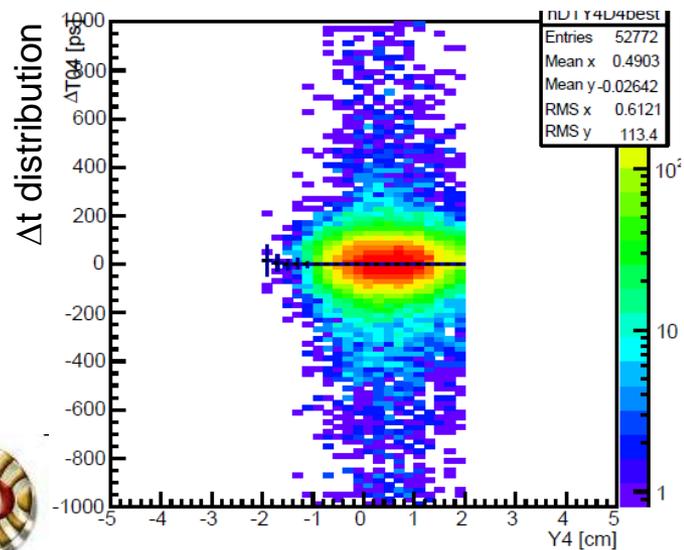




Edge effects

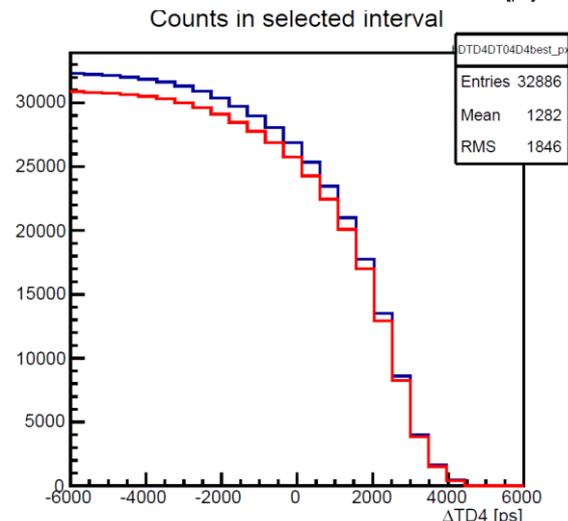
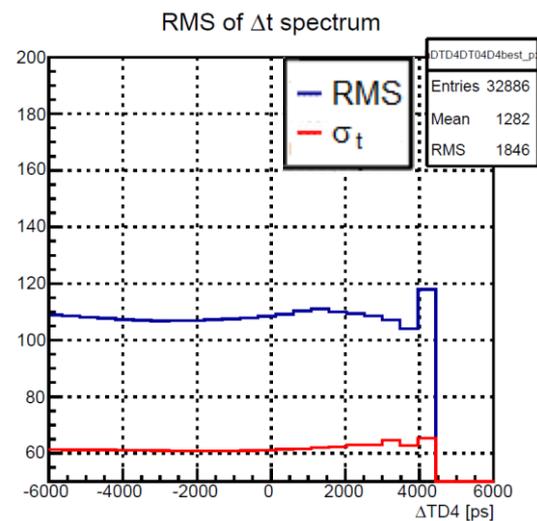
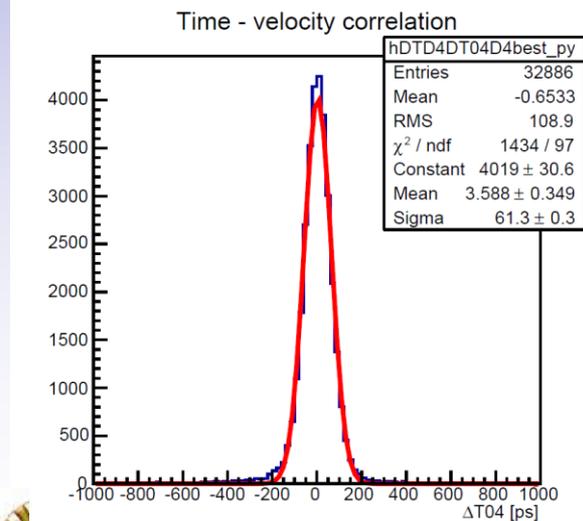
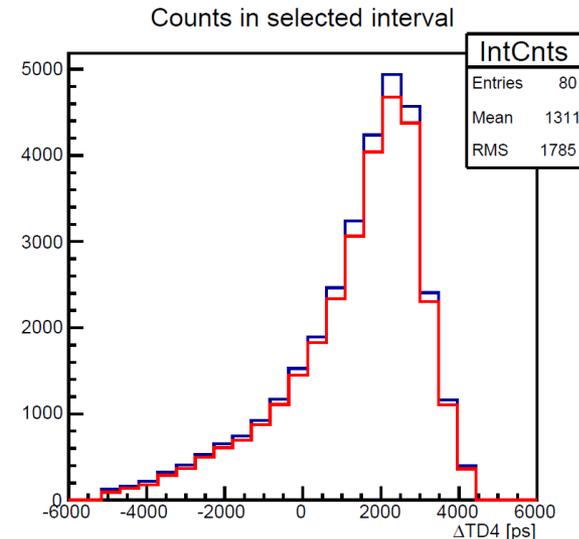
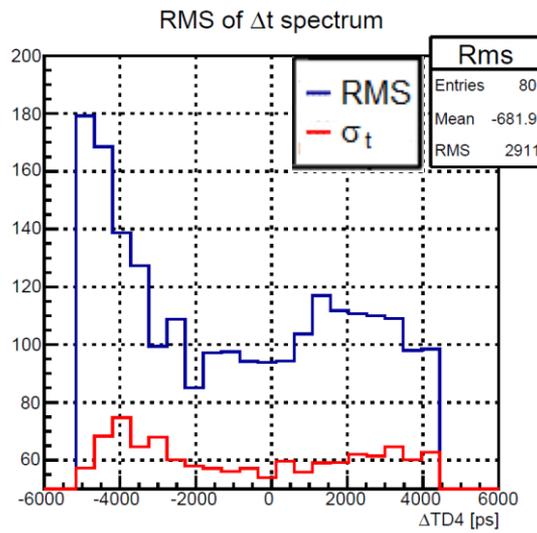
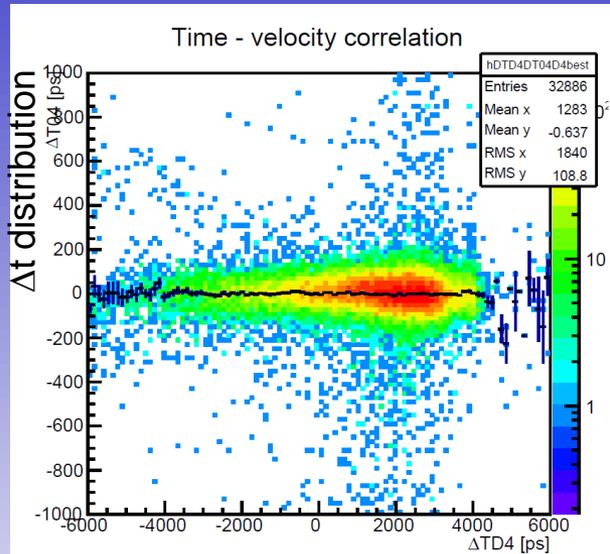
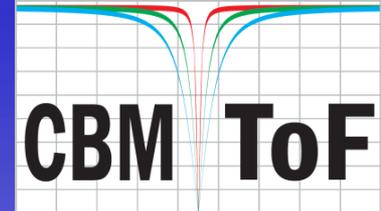


Cut selection on the reference counter





Time difference vs. particle velocity



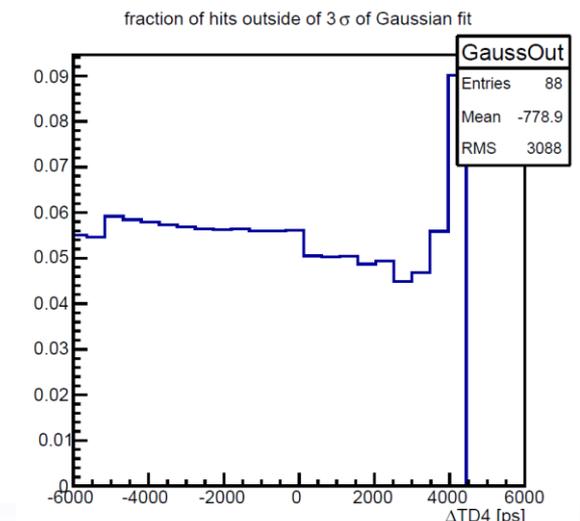
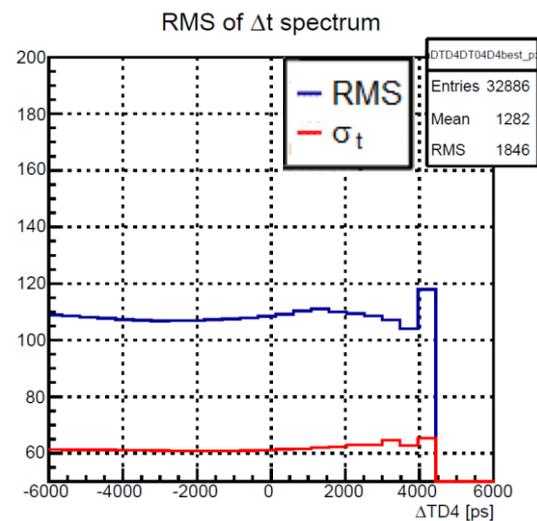
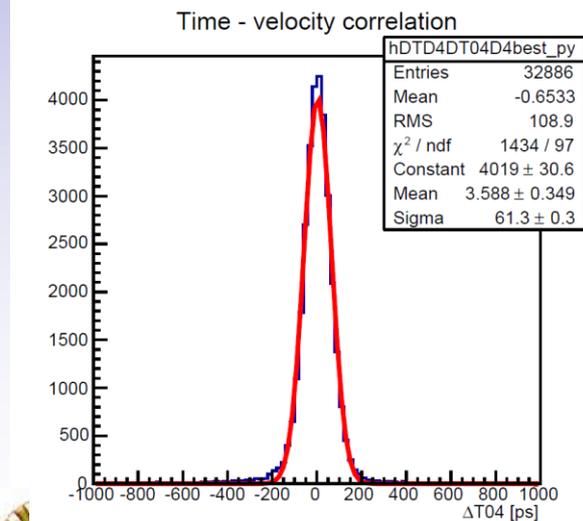
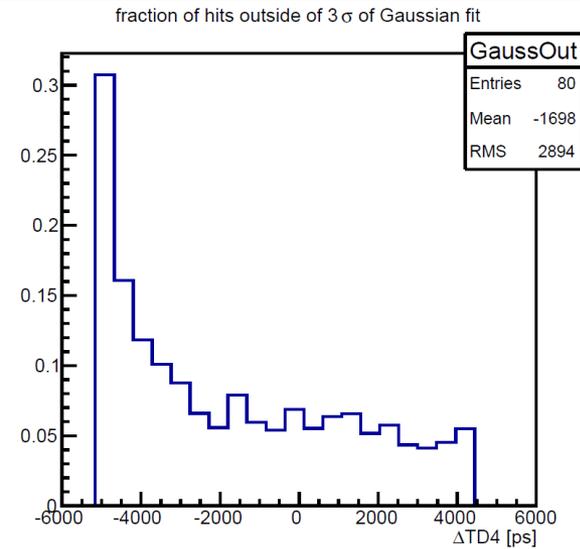
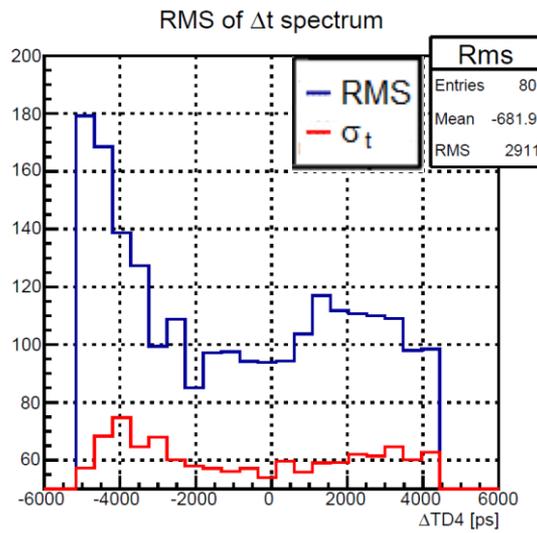
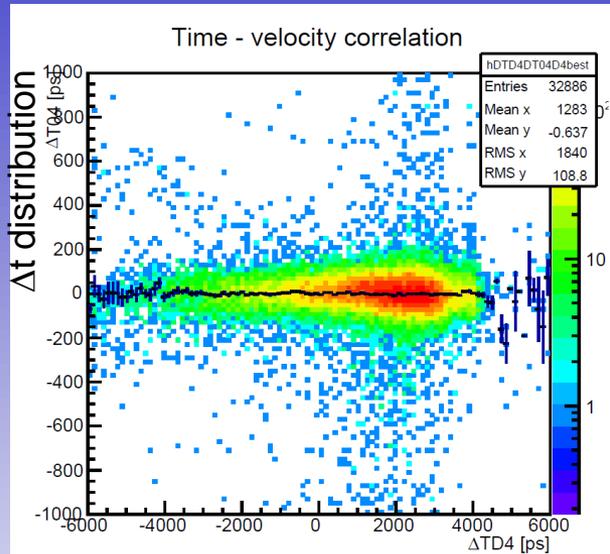
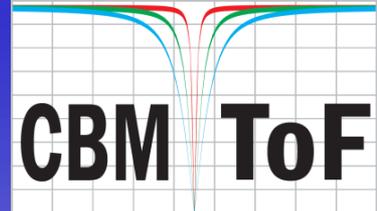
HV = 11 kV, $U_{thr} = 200$ mV

RPC 2016
Gent 22 - 26.02.2016





Time difference vs. particle velocity

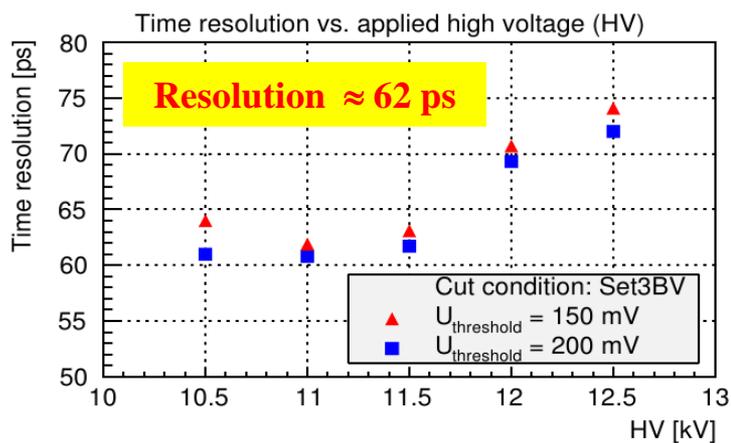


HV = 11 kV, $U_{thr} = 200$ mV

RPC 2016
Gent 22 - 26.02.2016

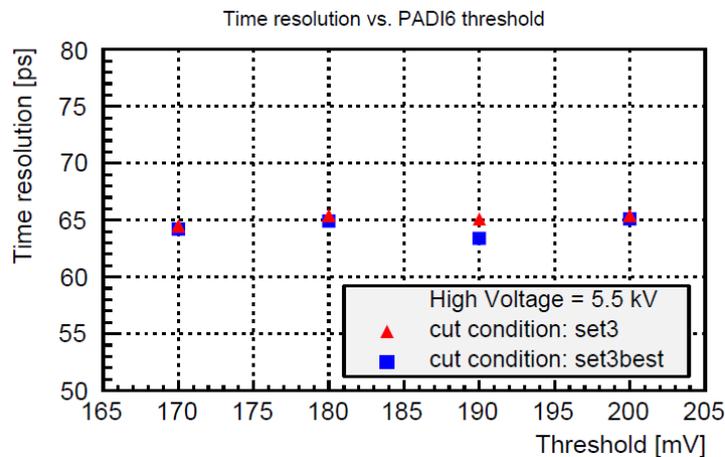
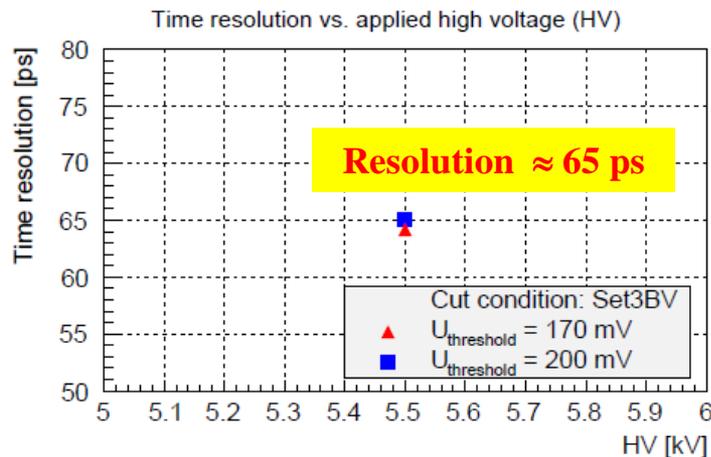


Differential singel stack MRPC
with 8 gaps



VS.

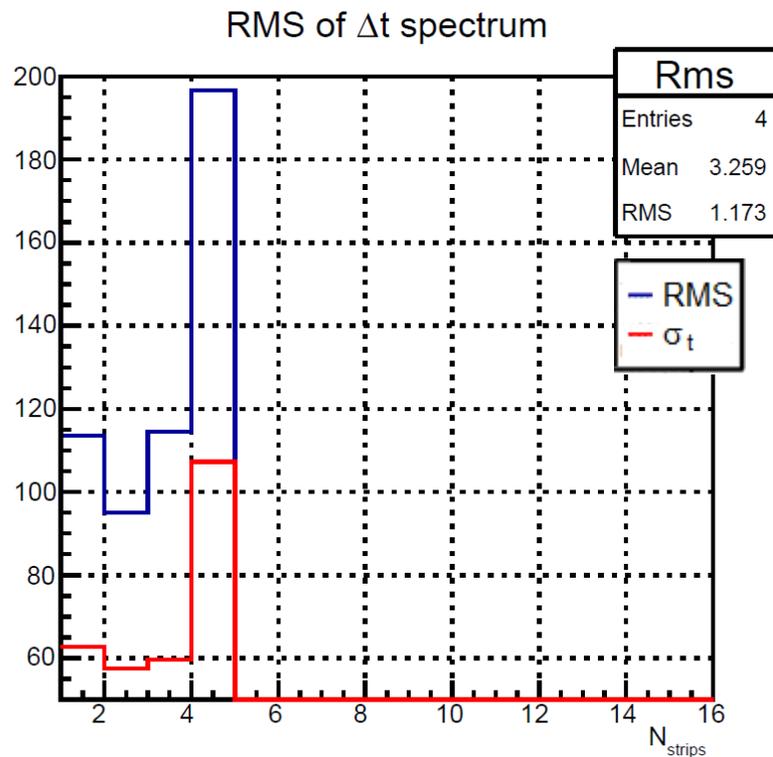
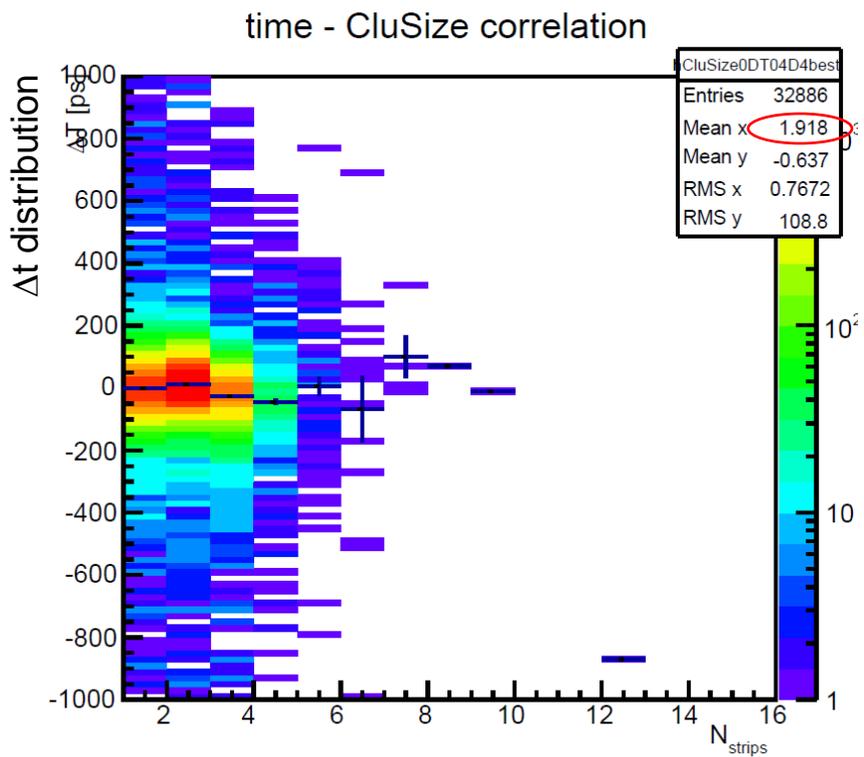
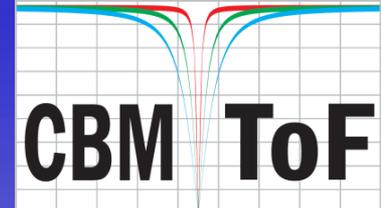
Differential double stack MRPC
with 2 x 4 gaps



- Data points at ± 11 kV in the left plot can be compared with ± 5.5 kV in the right plot.
- Single stack MRPC shows slightly time resolution.
- Single counter resolution is in the order of **45 ps** including all electronic components.



Cluster size

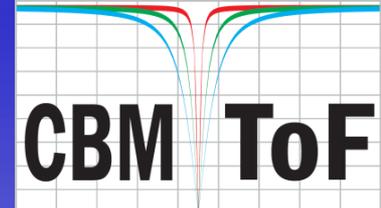


- Time resolution does not deteriorate with cluster size bigger than one

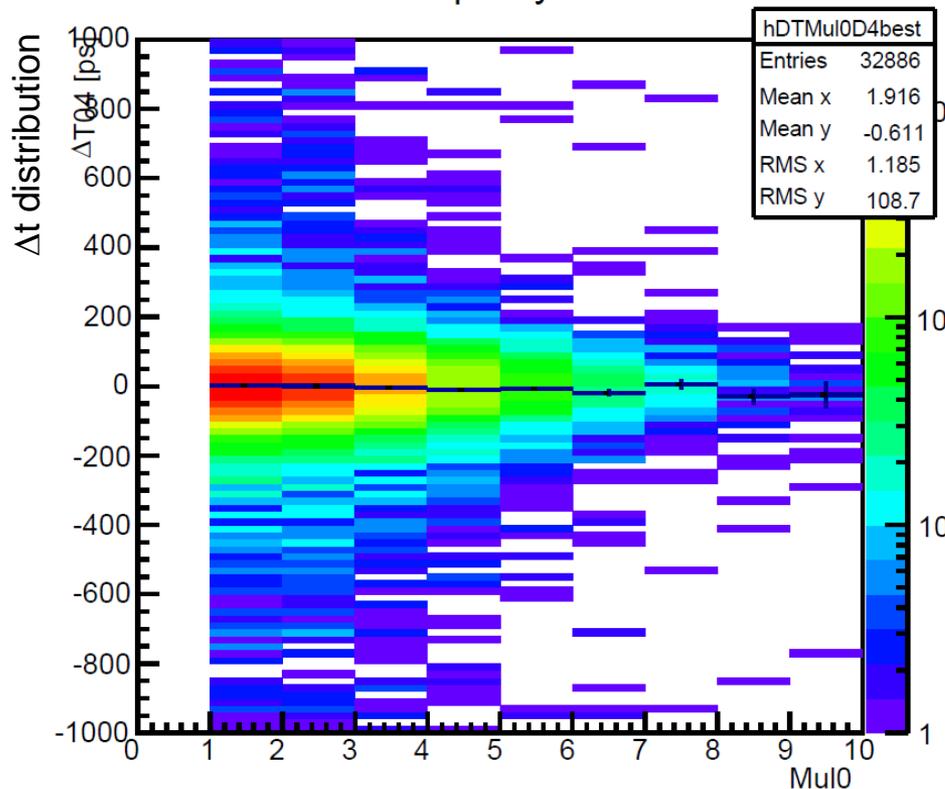




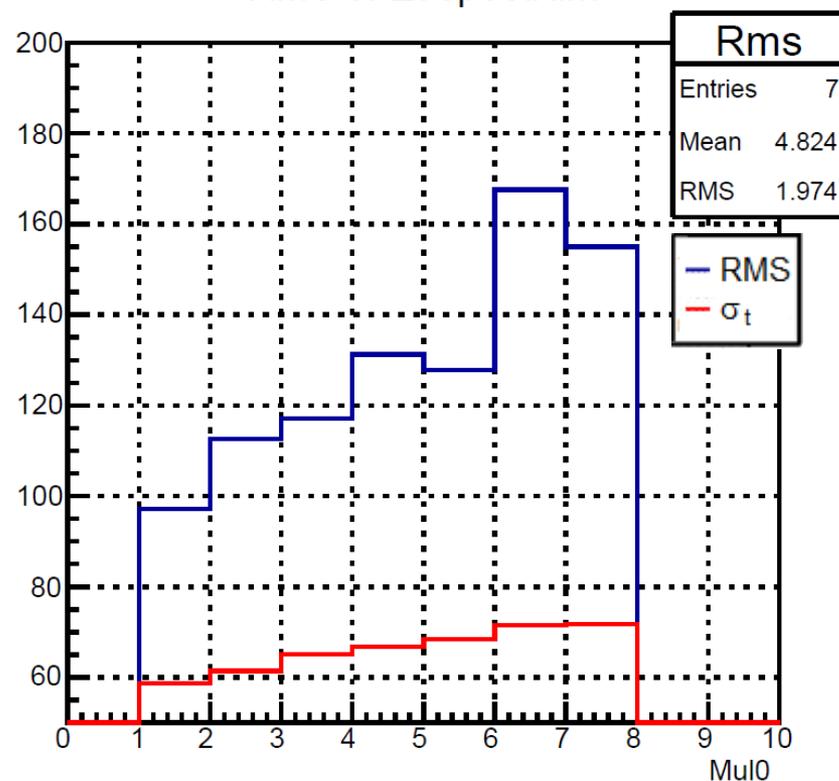
Cluster multiplicity



Time - Multiplicity correlation



RMS of Δt spectrum



- Counter time resolution below 50 ps up to the highest multiplicity @ an occupancy of about 50%

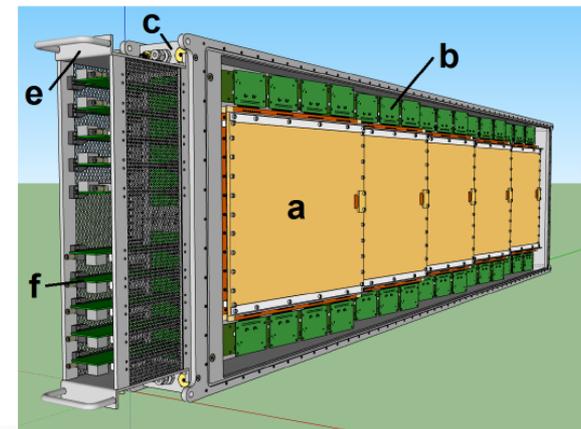


Summary

- TDR is approved. However no final decision regarding counter design is taken.
- The design of the differential single stack MRPC from Heidelberg is driven by the free-streaming readout \Rightarrow impedance matching is realized.
- The single stack MRPC shows slightly better efficiency and time resolution in comparison to a double stack MRPC.
- The double stack MRPC shows a smaller cluster size (about 1.6).
- Single counter resolution is in the order of **45 ps** including all electronic contributions.
- However, in a free running mode an impedance matched MRPC might show a better performance due to minimized signal reflections.

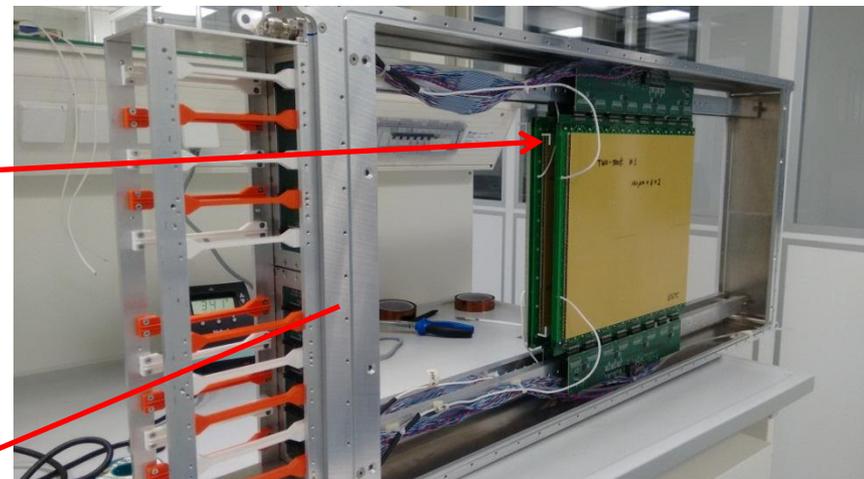
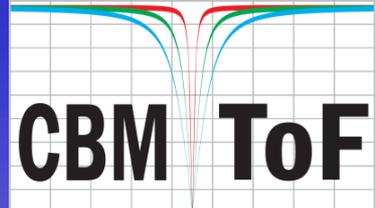
Outlook

- Load test for all available full size prototypes in Nov. 2015 with heavy ions at SPS CERN
- Among them 3 full size modules M4 with counters MRPC3a and MRPC3b were tested
- Data analysis is still ongoing
- Selection of the final layout and counter configurations this year based on beam time results.
- Start of the low resistive glass production this year



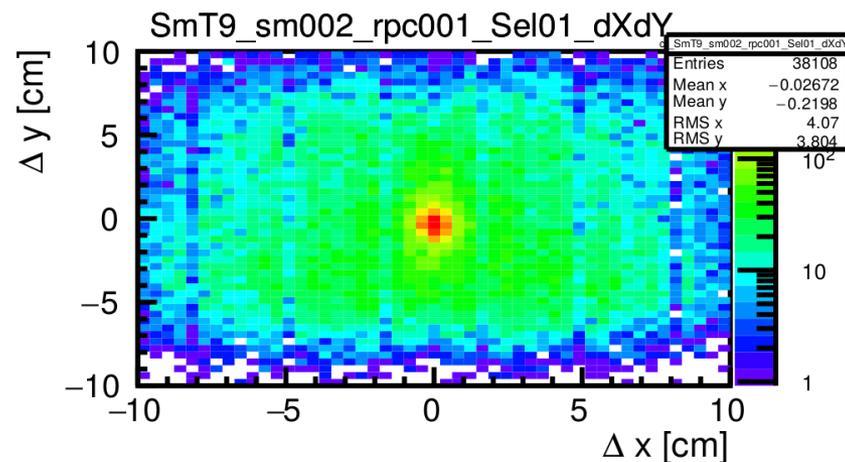
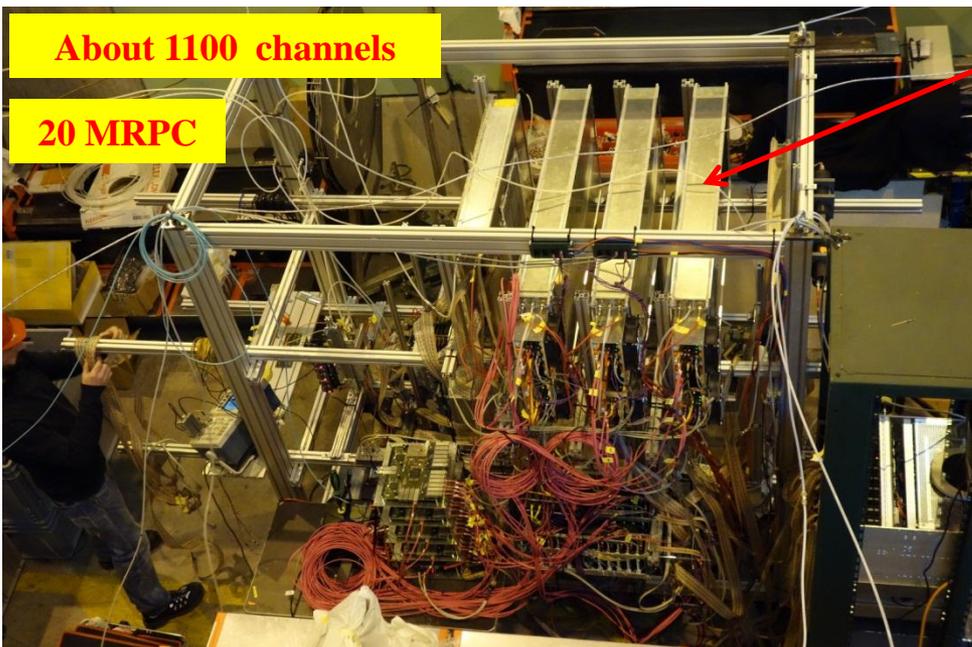


Outlook



About 1100 channels

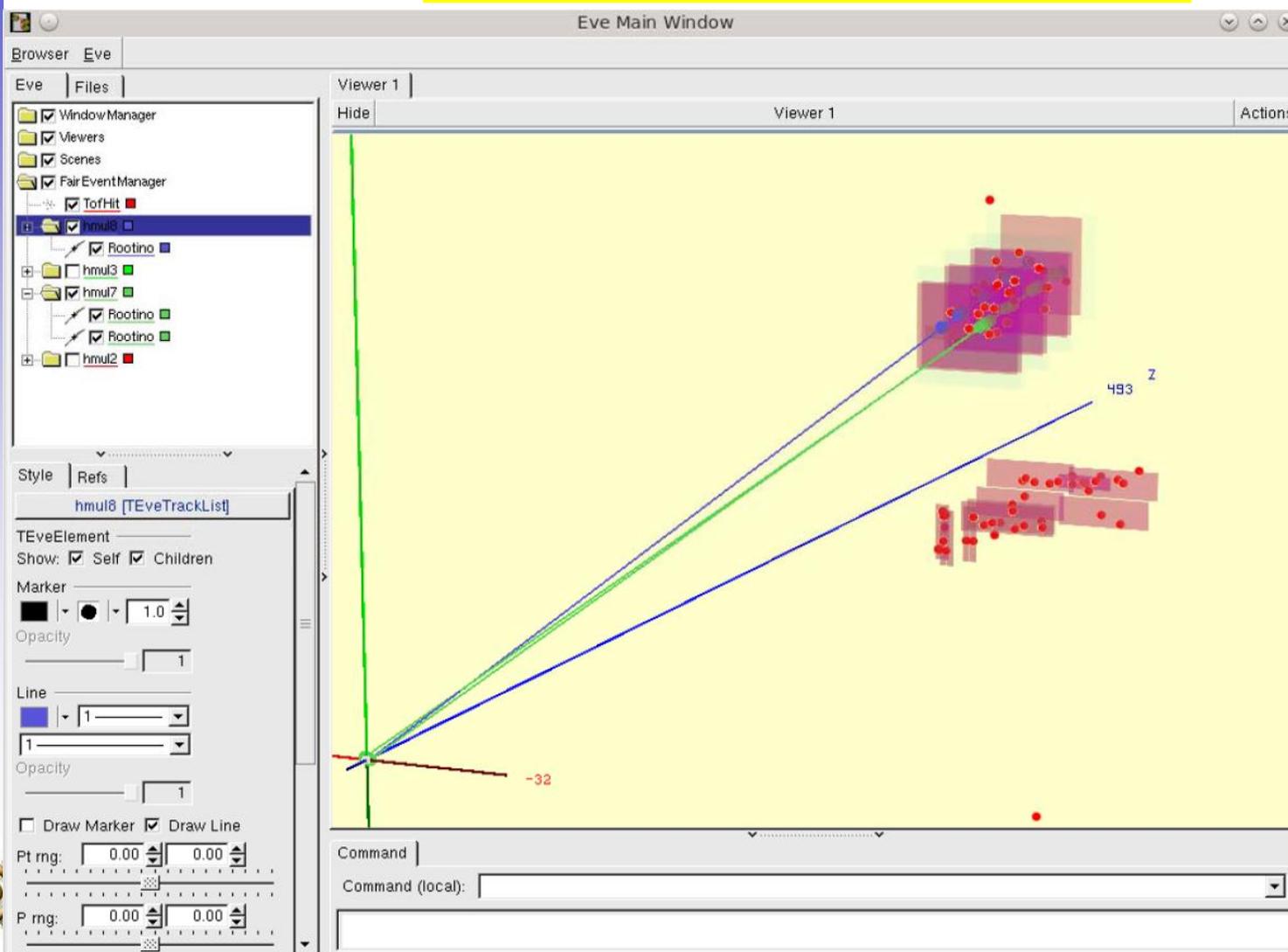
20 MRPC



$\sigma_x \approx 2.3 \text{ mm}$ & $\sigma_y \approx 3 \text{ mm}$



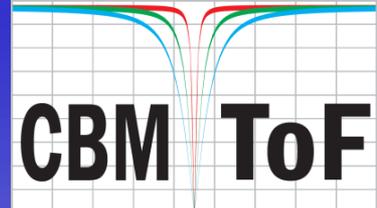
Event display after calibration



- 1 Track (blue) with mult. 8
- 2 Tracks (green) with mult. 7



Thank you for your attention



Contributing institutions:

Tsinghua Beijing,
NIPNE Bucharest,
GSI Darmstadt,
IRI Frankfurt
USTC Hefei,
PI Heidelberg,
ITEP Moscow,
HZDR Rossendorf,
CCNU Wuhan,

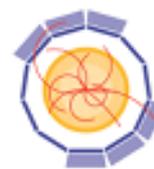
Special thanks go to:

Norbert Herrmann



bmb+f

Großgeräte
der physikalischen
Grundlagenforschung

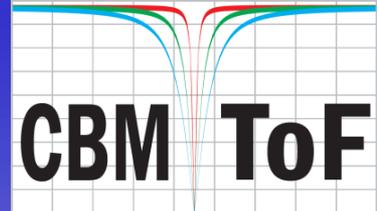


AIDA





Backup



Backup Slides

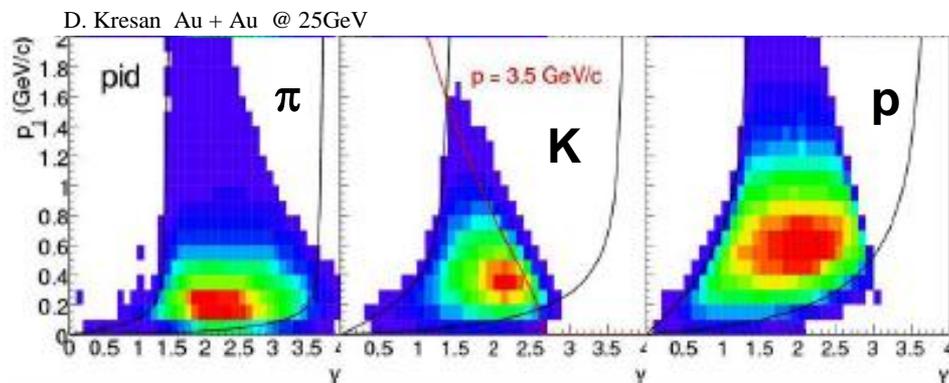
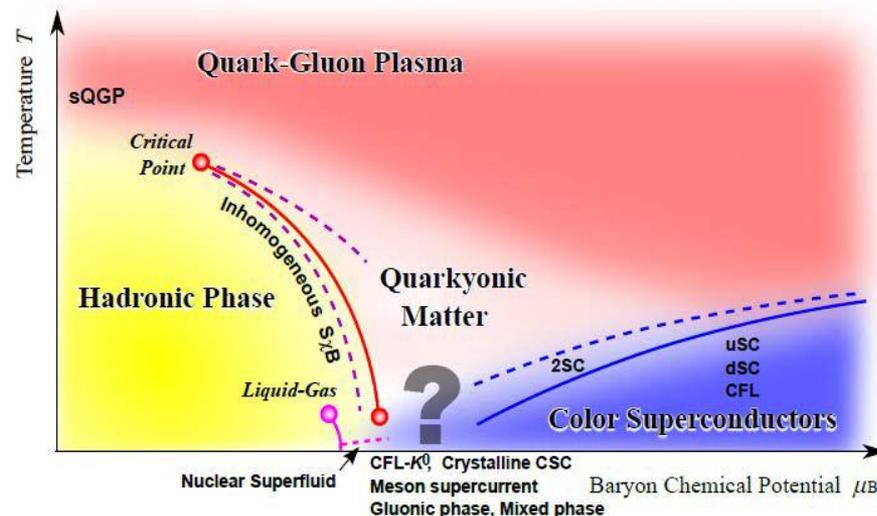


CBM Physics topics

- Deconfinement / phase transition at high ρ_B
- QCD critical endpoint
- The equation-of-state at high ρ_B
- chiral symmetry restoration at high ρ_B

Observables

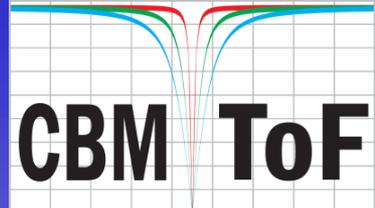
- excitation function and flow of strangeness and charm
- collective flow of hadrons
- particle production at threshold energies
- excitation function of event-by-event fluctuations
- excitation function of low-mass lepton pairs
- in-medium modifications of hadrons ($\rho, \omega, \phi \rightarrow e+e-(\mu+\mu-), D$)



Kaon acceptance depends critically on TOF resolution



Backup Slides



T0 – determination

Diamond start counter

- use HADES development,
- develop DAQ interface,
- limited to reaction rates $\sim 100\text{kHz}$

Software solution

- available for all systems
- needs fast particles from reaction
- demonstrated to work for central and semi-central heavy system

Beam fragmentation counter

- peripheral HI – reaction have fast particles from projectile fragmentation
- equip region E with timing counters (BFTC)

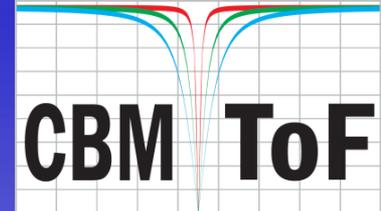
Reaction counter

- needed for high rate pA – reactions (charm at SIS 100)
- reaction counter at polar angles $35^\circ < \theta < 60^\circ$.



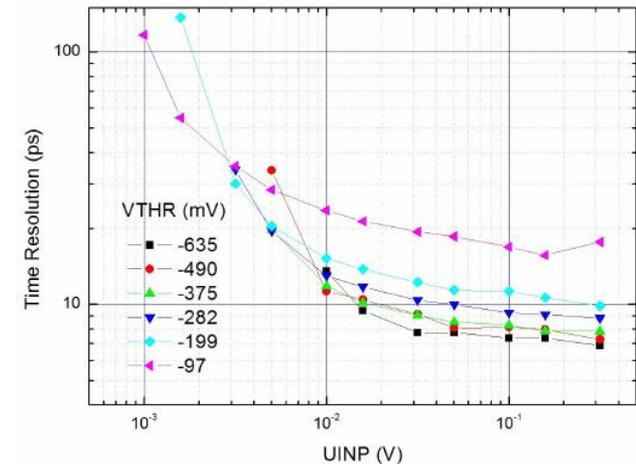


Backup Slides



Main parameters comparison	PADI-1	PADI-2	PADI-6	PADI-8
Channels per chip	3	4	4	8
PA Bandwidth (MHz)	280	293	416	411
PA Voltage Gain	74	87	244	251
Conversion Gain (mV/fC)	6.3	7.8	35	30
Baseline DC offset σ (mV)	6.7	21.9	5.9	1
PA Noise (mV_{RMS})	3.37	2.19	5.82	5.5
Equivalent Noise Charge (e_{RMS})	3512	1753	1039	1145
Threshold type	Extern	Extern	Ext. & DAC	DAC
Threshold dynamics (\pm mV)	Non.lin. 280	Non.lin. 300	Lin. 500	Lin. 750
Input Impedance Range (Ω)	30-450	37 - 370	38 - 165	30 - 160
Power consumption (mW/channel)	21.6	17.4	17.7	17

Table 3.4: Main parameters of the PAD.



Selection cuts in ana_hits.C

```

void AnaHits::SetCuts(iSel){
    fCuts = 0;
    SetCuts(iSel){ // selection cuts
        fCuts = 0;
        tofAnaTestbeam->SetMul4Max(10); // Max Multiplicity in Ref - RPC
        tofAnaTestbeam->SetCh4Sel(8.); // Center of channel selection window
        tofAnaTestbeam->SetDCh4Sel(70.); // Width of channel selection window
        tofAnaTestbeam->SetPosY4Sel(10.5); // Y Position selection in fraction of strip length
        tofAnaTestbeam->SetMulDMax(10.); // Max Multiplicity in Diamond
        tofAnaTestbeam->SetDTDia(0.); // Time difference to additional diamond
    }
}

```

```

void AnaHits::SetCuts(1){
    tofAnaTestbeam->SetMul0Max(10); // Max Multiplicity in dut - RPC
    tofAnaTestbeam->SetMul4Max(1); // Max Multiplicity in Ref - RPC
    tofAnaTestbeam->SetCh4Sel(8.); // Center of channel selection window
    tofAnaTestbeam->SetDCh4Sel(7.); // Width of channel selection window
    tofAnaTestbeam->SetPosY4Sel(0.5); // Y Position selection in fraction of strip length
    tofAnaTestbeam->SetMulDMax(1.); // Max Multiplicity in Diamond
    tofAnaTestbeam->SetDTDia(0.); // Time difference to additional diamond
}

```

Cut 1

```

void AnaHits::SetCuts(2){
    tofAnaTestbeam->SetMul4Max(1); // Max Multiplicity in Ref - RPC
    tofAnaTestbeam->SetCh4Sel(8.); // Center of channel selection window
    tofAnaTestbeam->SetDCh4Sel(7.); // Width of channel selection window
    tofAnaTestbeam->SetPosY4Sel(0.5); // Y Position selection in fraction of strip length
    tofAnaTestbeam->SetMulDMax(1.); // Max Multiplicity in Diamond
    tofAnaTestbeam->SetDTDia(500.); // Time difference to additional diamond
}

```

```

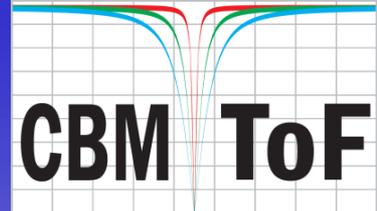
void AnaHits::SetCuts(3){
    tofAnaTestbeam->SetMul4Max(1); // Max Multiplicity in Ref - RPC
    tofAnaTestbeam->SetCh4Sel(8.); // Center of channel selection window
    tofAnaTestbeam->SetDCh4Sel(4.); // Width of channel selection window
    tofAnaTestbeam->SetPosY4Sel(0.3); // Y Position selection in fraction of strip length
    tofAnaTestbeam->SetMulDMax(1.); // Max Multiplicity in Diamond
    tofAnaTestbeam->SetDTDia(500.); // Time difference to additional diamond
}

```

Cut 3



Cuts



Selection cuts in ana_hits.C

```

TTree *T = new TTree("T", "ana_hits");
T->Branch("iSel", "int", "iSel");
T->Branch("iSel", "int", "iSel"); // selection cuts
T->Branch("iSel", "int", "iSel");

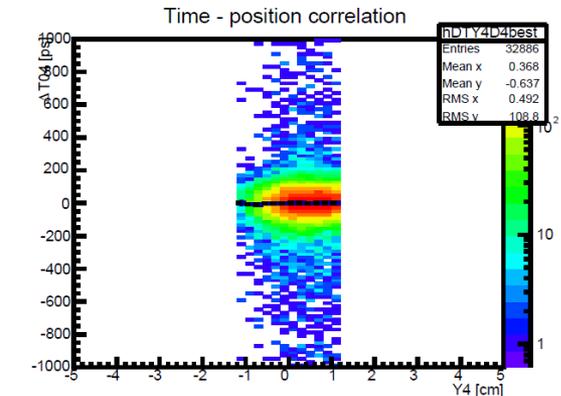
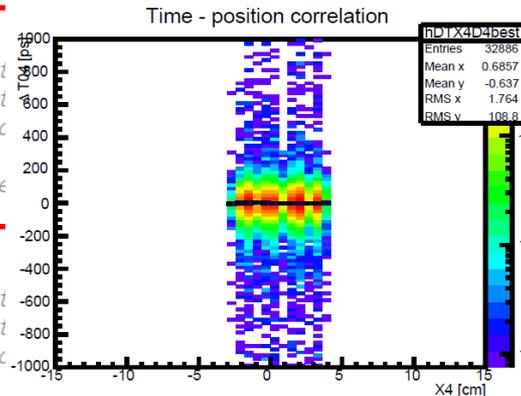
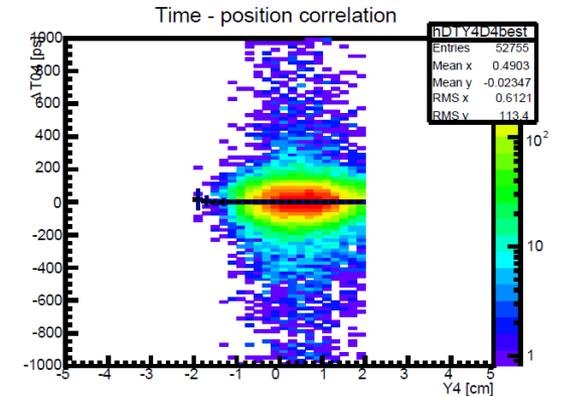
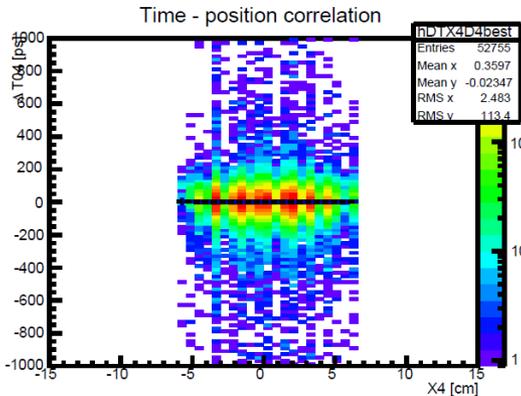
// Selection cut 0
tofAnaTestbeam->SetMul4Max(10); // Max Multiplicity in Diamond
tofAnaTestbeam->SetCh4Sel(8.); // Center of Diamond
tofAnaTestbeam->SetDCh4Sel(70.); // Width of Diamond
tofAnaTestbeam->SetPosY4Sel(10.5); // Y Position of Diamond
tofAnaTestbeam->SetMulDMax(10.); // Max Multiplicity in Diamond
tofAnaTestbeam->SetDTDia(0.); // Time difference to additional diamond

// Selection cut 1
tofAnaTestbeam->SetMul0Max(10); // Max Multiplicity in Diamond
tofAnaTestbeam->SetMul4Max(1); // Max Multiplicity in Diamond
tofAnaTestbeam->SetCh4Sel(8.); // Center of Diamond
tofAnaTestbeam->SetDCh4Sel(7.); // Width of Diamond
tofAnaTestbeam->SetPosY4Sel(0.5); // Y Position of Diamond
tofAnaTestbeam->SetMulDMax(1.); // Max Multiplicity in Diamond
tofAnaTestbeam->SetDTDia(0.); // Time difference to additional diamond

// Selection cut 2
tofAnaTestbeam->SetMul4Max(1); // Max Multiplicity in Diamond
tofAnaTestbeam->SetCh4Sel(8.); // Center of Diamond
tofAnaTestbeam->SetDCh4Sel(7.); // Width of Diamond
tofAnaTestbeam->SetPosY4Sel(0.5); // Y Position of Diamond
tofAnaTestbeam->SetMulDMax(1.); // Max Multiplicity in Diamond
tofAnaTestbeam->SetDTDia(500.); // Time difference to additional diamond

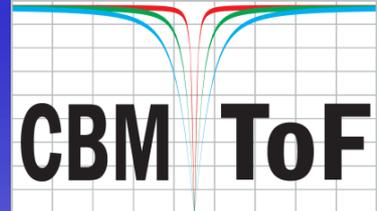
// Selection cut 3
tofAnaTestbeam->SetMul4Max(1); // Max Multiplicity in Diamond
tofAnaTestbeam->SetCh4Sel(8.); // Center of Diamond
tofAnaTestbeam->SetDCh4Sel(4.); // Width of Diamond
tofAnaTestbeam->SetPosY4Sel(0.3); // Y Position of Diamond
tofAnaTestbeam->SetMulDMax(1.); // Max Multiplicity in Diamond
tofAnaTestbeam->SetDTDia(500.); // Time difference to additional diamond

```

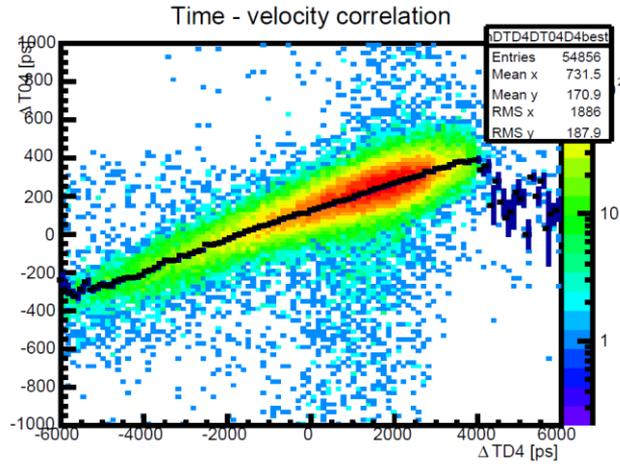




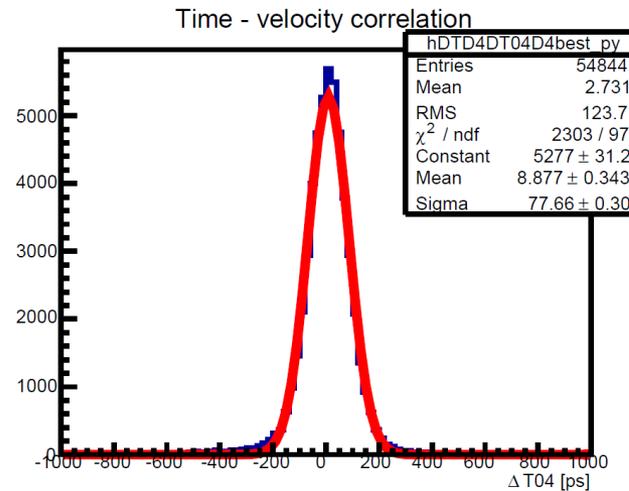
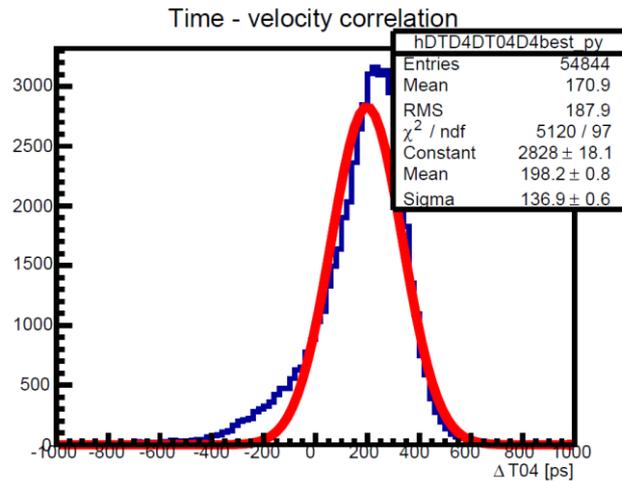
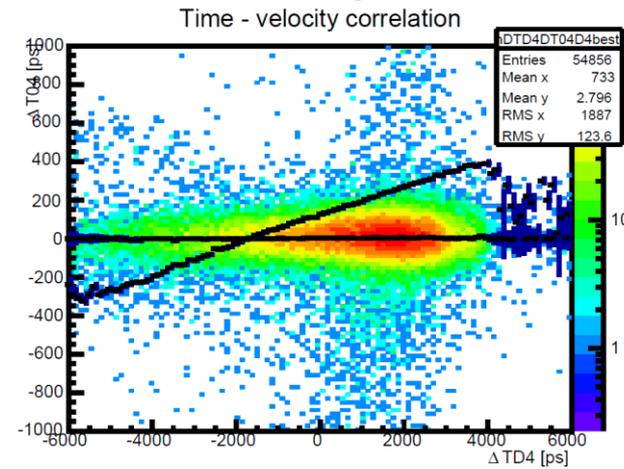
Time – velocity correlation



Step 1 (after init_calib)



Step 2



Differential single stack MRPC
with 8 gas gaps

VS.

Differential double stack MRPC
with 2 x 4 gas gaps

